

STTH30W02C

Turbo 2 ultrafast high voltage rectifier

Datasheet - production data

Features

- Ultrafast switching
- Low reverse recovery current
- Low thermal resistance
- Reduces switching losses
- ECOPACK[®]2 compliant component

Description

The STTH30W02CW, uses ST Turbo 2, 200 V technology. It is especially suited to be used for DC/DC and DC/AC converters in secondary stage of MIG/MMA/TIG welding machine. Housed in ST's TO-247, this device offers high power integration for all welding machines and industrial applications.

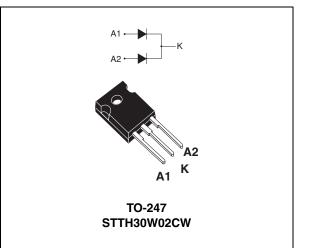


Table 1. **Device summary**

Symbol	Value
I _{F(AV)}	2 x 15 A
V _{RRM}	200 V
t _{rr} (typ)	20 ns
T _j (max)	175 °C
V _F (typ)	0.90 V

1 Characteristics

Table 2. Absolute ratings (limiting values, at 25 °C, unless otherwise specified)

Symbol	Paramete	Value	Unit			
V _{RRM}	Repetitive peak reverse voltage	200	V			
I _{F(RMS)}	Forward rms current	Forward rms current				
1	Average forward current, $\delta = 0.5$	T _c = 125 °C	Per diode	15	А	
^I F(AV)	Average forward current, $\delta = 0.5$	$T_c = 115^{\circ}C$	Per device	30		
I _{FSM}	Surge non repetitive forward current t _p = 10 ms sinusoidal			140	А	
T _{stg}	Storage temperature range	-65 to + 175	°C			
Тj	Maximum operating junction tempera		+ 175	°C		

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit	
Б	lupotion to acco	Per diode	2.5	
R _{th(j-c)}	Junction to case	1.5	°C / W	
R _{th(c)}	Coupling		0.5	

When diodes 1 and 2 are used simultaneously:

 $T_j(diode 1) = P(diode 1) \times R_{th(j-c)}(per diode) + P(diode 2) \times R_{th(c)}$

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур	Max.	Unit
I _R ⁽¹⁾ Reverse leakage current	Povorco lookago ourront	T _j = 25 °C				10	
	T _j = 125 °C	$V_{R} = V_{RRM}$		5	50	μA	
	V _F ⁽²⁾ Forward voltage drop	T _j = 25 °C	I _F = 15A			1.20	
V ⁽²⁾		T _j = 150 °C			0.90	1.05	v
VF		T _j = 25 °C	I _F = 30 A			1.4	v
		T _j = 150 °C			1.1	1.3	

1. Pulse test: $t_p = 5 \text{ ms}, \delta < 2\%$

2. Pulse test: t_p = 380 μ s, δ < 2%

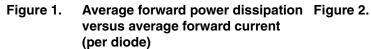
To evaluate the conduction losses use the following equation:

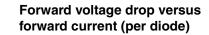
 $P = 0.8 \text{ x } I_{F(AV)} + 0.0167 I_{F}^{2}_{(RMS)}$



Symbol	Parameter	Test conditions		Min.	Тур	Max.	Unit
I _{RM}	Reverse recovery current				7	9	А
Q _{RR}	Reverse recovery charge	T _j = 125 °C	I _F = 15 A, V _R = 160 V dI _F /dt = -200 A/µs		160		nC
S _{factor}	Softness factor				0.3		
t _{rr}	Reverse recovery time	T _j = 25 °C	I _F = 1 A, V _R = 30 V dI _F /dt = -100 A/μs		20	25	ns
t _{fr}	Forward recovery time	T _j = 25 °C	I _F = 15 A, V _{FR} = 1.1 V			200	ns
V _{FP}	Forward recovery voltage	T _j = 25 °C	dI _F /dt = 100 A/µs		1.6	2.4	V

Table 5. **Dynamic electrical characteristics**





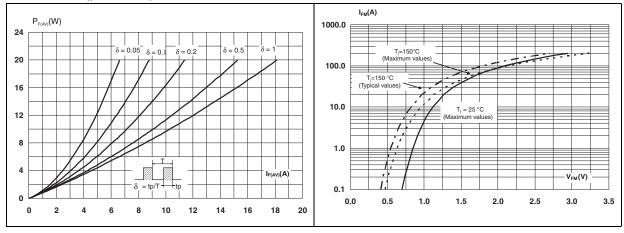
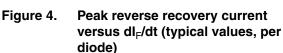
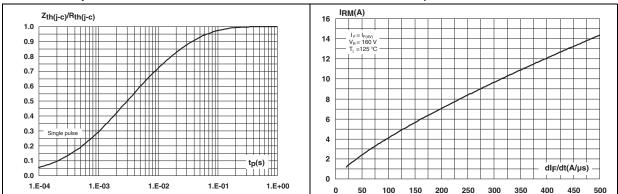


Figure 3. **Relative variation of thermal** impedance junction to case versus pulse duration







dlF/dt(A/µs)

Figure 5. Reverse recovery time versus dI_F/dt Figure 6. (typical values, per diode)

Reverse recovery charges versus dl_F/dt (typical values, per diode)

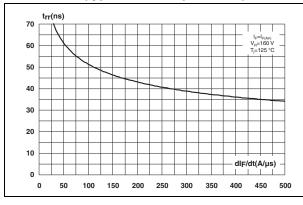
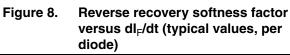
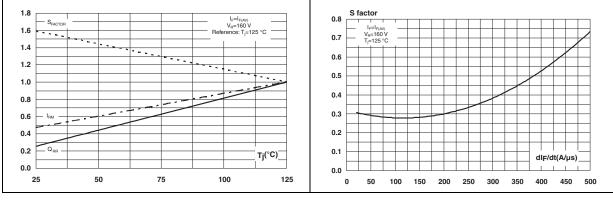


Figure 7. Relative variations of dynamic parameters versus junction temperature





Q_{RR}(nC)

I_F=I_{F(AV)} V_R=160 V T_j=125 °C

300

250

200

150

100

50

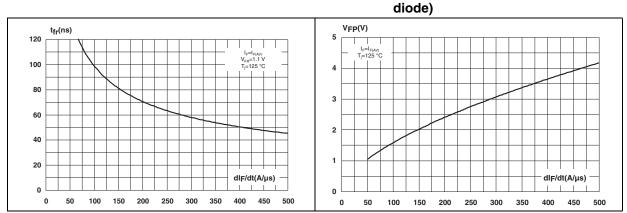
0

0 50

100 150 200 250 300 350 400 450 500

Figure 9. Forward recovery time versus dI_F/dt Figure 10. (typical values, per diode)

Transient peak forward voltage versus dl_F/dt (typical values, per





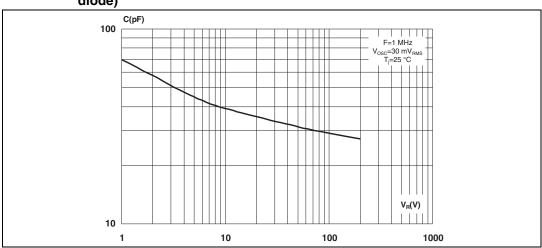


Figure 11. Junction capacitance versus reverse voltage applied (typical values, per diode)



2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.55 N·m (1.0 N·m maximum)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

Table 6. TO-247 dimensions

					Dimer	nsions		
			Mi	illimete	ers		Inches	
			Min.	Тур.	Max.	Min.	Тур	Max.
	А	4.85		5.15	0.191		0.203	
1		A1	2.20		2.60	0.086		0.102
		b	1.00		1.40	0.039		0.055
: E → A Heat-sink plane	b1	2.00		2.40	0.078		0.094	
tst total AB		b2	3.00		3.40	0.118		0.133
		С	0.40		0.80	0.015		0.031
L2		D ⁽¹⁾	19.85		20.15	0.781		0.793
	E	15.45		15.75	0.608		0.620	
	$ \begin{array}{c ccccc} \downarrow & \downarrow & \downarrow & \downarrow & \downarrow & \downarrow \\ \downarrow & \downarrow & \downarrow & \downarrow & \downarrow & \downarrow \\ \downarrow & \downarrow & \downarrow & \downarrow & \downarrow & \downarrow \\ \downarrow & \downarrow & \downarrow & \downarrow & \downarrow & \downarrow \\ \downarrow & \downarrow & \downarrow & \downarrow & \downarrow & \downarrow & \downarrow \\ \downarrow & \downarrow \\ \downarrow & \downarrow &$	е	5.30	5.45	5.60	0.209	0.215	0.220
·		L	14.20		14.80	0.559		0.582
e		L1	3.70		4.30	0.145		0.169
		L2	1	8.50 ty	p.	0	.728 typ	D.
		ØP ⁽²⁾	3.55		3.65	0.139		0.143
		ØR	4.50		5.50	0.177		0.217
		S	5.30	5.50	5.70	0.209	0.216	0.224

1. Dimension D plus gate protrusion does not exceed 20.5 mm

2. Resin thickness around the mounting hole is not less than 0.9 mm



3 Ordering information

Table 7. Ordering information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STTH30W02CW	STTH30W02CW	TO-247	4.46 g	50	Tube

4 Revision history

Table 8.Document revision history

Date	Revision	Changes
05-Oct-2012	1	First issue.



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